



ABSTRACT

The TPS22916ALLEVM evaluation module (EVM) allows the user to connect power to and control the 4-pin YFP package load switch. Parameters such as the on-resistance, rise time and output pull-down resistance can be easily evaluated. [Table 1-1](#) lists a short description of the TPS22916 load switch performance specifications. For additional details on load switch performance, application notes, and the data sheet see [Load Switches](#).

Table 1-1. TPS22916 Rise Time, Output Current Rating, Enable, and Output Discharge Characteristics

EVM	Device	Rise Time Typical	VIN (V)	Maximum Continuous Current	Enable (ON Pin)	Quick Output Discharge
PSIL189-001	TPS22916C	1400 μ s	5.5	2 A	Active High	Yes
	TPS22916B	105 μ s	5.5	2 A	Active High	Yes
	TPS22916CL	1400 μ s	5.5	2 A	Active Low	Yes
	TPS22916CN	1400 μ s	5.5	2 A	Active High	No
	TPS22916CNL	1400 μ s	5.5	2 A	Active Low	No
	TPS22916BL	105 μ s	5.5	2 A	Active Low	Yes

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1 Introduction

1.1 Description

The TPS22916ALLEVM is a two-sided PCB containing the TPS22916C, TPS22916B, TPS22916CL, TPS22916CN, TPS22916CNL and TPS22916BL load switch devices. The VIN and VOUT connections to the device and the PCB layout routing are capable of handling high continuous currents and provide a low resistance pathway into and out of the device under test. Test point connections allow the EVM user to control the device with user defined test conditions and make accurate R_{ON} measurements.

1.2 Features

- VIN input voltage range: 1 V to 5.5 V
- EVM allows access to the VIN, VOUT, GND, and ON pin of the *TPS22916 Load Switch Devices*
- On-board C_{IN} and C_{OUT} capacitors
- 2-A maximum continuous current operation
- This evaluation module comes with the TPS22916C, TPS22916B, TPS22916CL, TPS22916CN, TPS22916CNL, and TPS22916BL

2 Electrical Performance

See the TPS22916 data sheet, [TPS22916xx 1-V – 5.5-V, 2-A, 60-m \$\Omega\$ Ultra-Low Leakage Load Switch](#), for detailed electrical characteristics.

3 Schematic

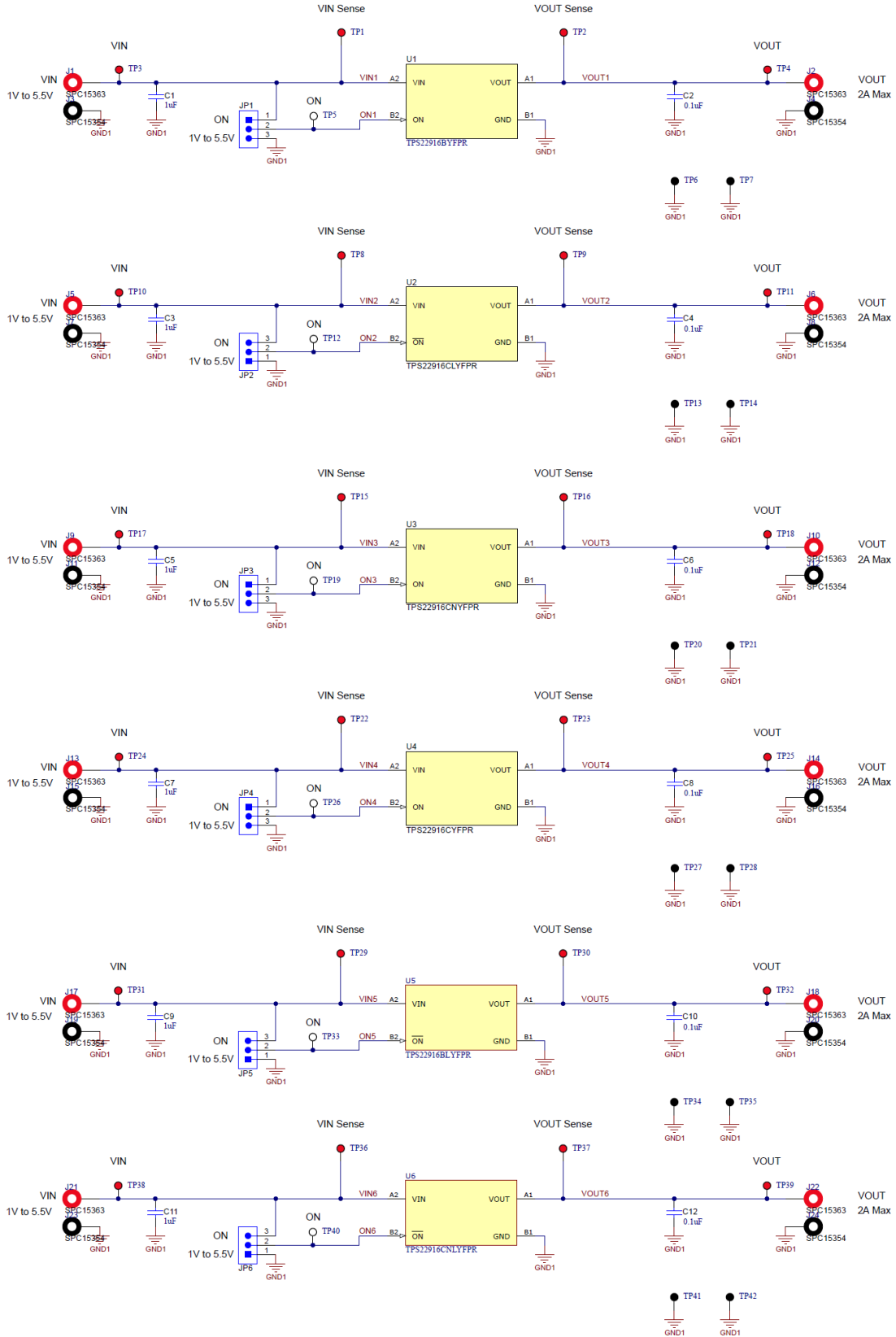


Figure 3-1. TPS22916ALLEVM Schematic

4 Layout

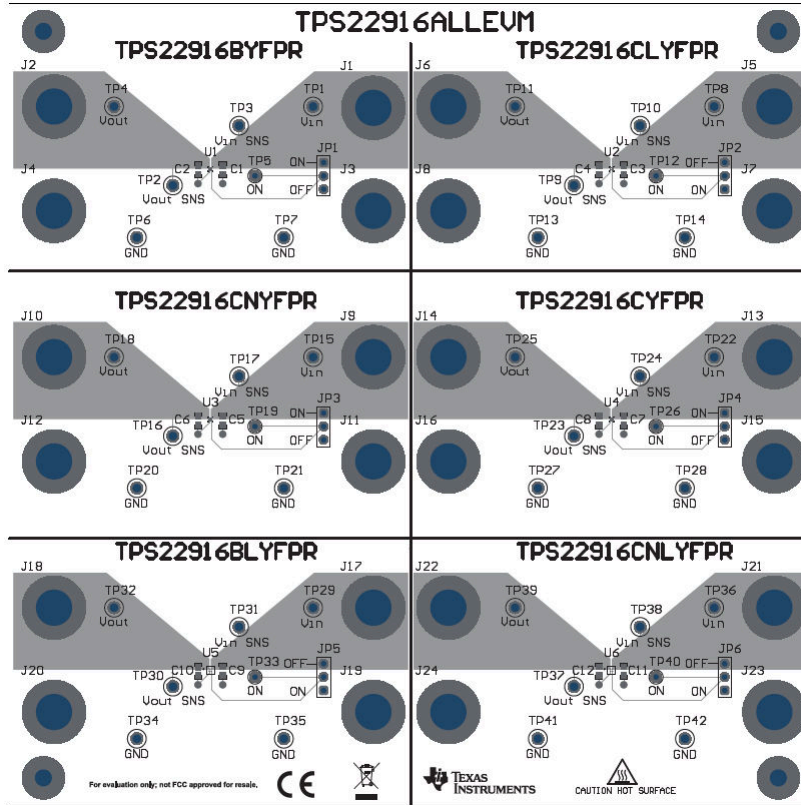


Figure 4-1. TPS22916ALLEVM Top Layout

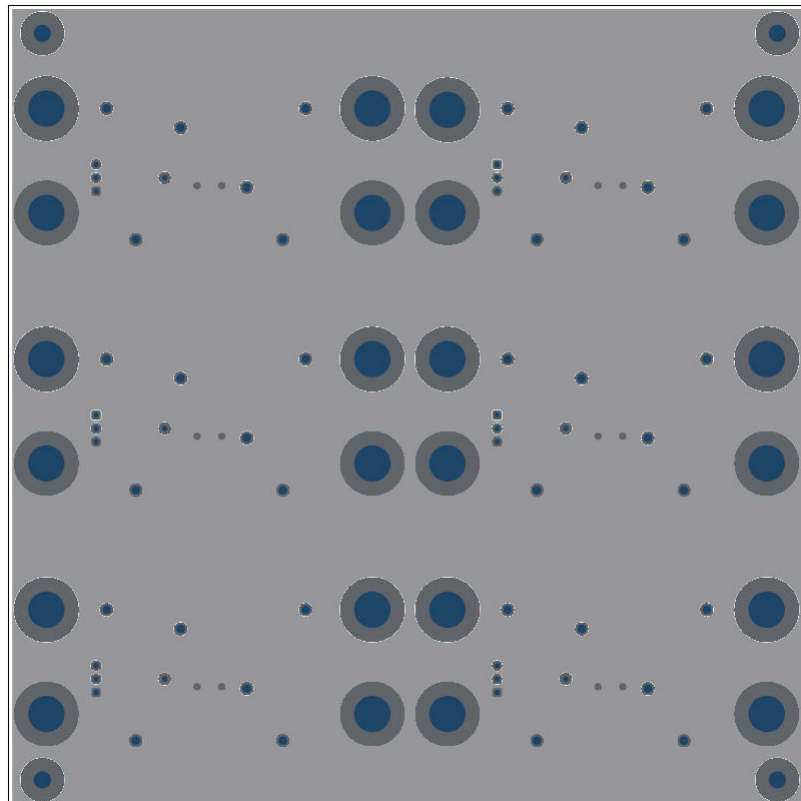


Figure 4-2. TPS22916ALLEVM Bottom Layout

4.1 Setup

This section describes the jumpers and connectors on the EVM as well as how to properly connect, setup, and use the EVM.

4.1.1 J1/J3/J5/J9/J13/J17/J21 – Input Connection

The input connection is the connection for the leads from the input source. Connect the positive lead to the J1/J3/J5/J9/J13/J17/J21 "+" terminal and the negative lead to the "-" terminal (GND).

4.1.2 J2/J6/J10/J14/J18/J22 – Output Connection

The output connection is the connection for the output of the EVM. Connect the positive lead to the J2/J6/J10/J14/J18/J22 "+" terminal and the negative lead to the "-" terminal (GND).

4.1.3 JP1/JP2/JP3/JP4/JP5/JP6 – ON

The ON is the enable input for the device. A shorting jumper must be installed on JP1/JP2/JP3/JP4/JP5/JP6 in either the ON or OFF position. The TPS22916C/B/CN is active high, and the TPS22916CL/CNL/BL is active low. ON must not be left floating. An external enable source can be applied to the EVM by removing the shunt and connecting a signal to TP5/TP12/TP19/TP26/TP33/TP40. Refer to the data sheet for proper ON and OFF voltage level settings. A switching signal can also be used and connected at this point.

4.1.4 TP3/TP10/TP17/TP24/TP31/TP38 – VIN Sense, TP2/TP9/TP16/TP23/TP30/TP37 – VOUT Sense

These two connections are used when very accurate measurements of the input or output are required. RON measurements must be made using these sense connections when measuring the voltage drop from VIN to VOUT to calculate the resistance.

4.1.5 TP6/TP7/TP13/TP14/TP20/TP21/TP27/TP28/TP34/TP35/TP41/TP42 – GND

These are connections to GND.

5 Operation

Connect the positive input of the VIN power supply to VIN at the positive terminal of J1/J3/J5/J7/JP9/JP13/JP17/JP21. Connect the negative lead of the power supply to GND at the negative terminal of J1/J3/J5/J7/JP9/JP13/JP17/JP21. The input voltage range of the TPS22916ALLEVM is 1 V to 5.5 V.

External output loads can be applied to the switch by using J2/J6/J10/J14/J18/J22. The TPS22916ALLEVM is rated for a maximum continuous current of 2 A. Configure JP1/JP2/JP3/JP4/JP5/JP6 as required. A shunt must be installed for proper operation. When the ON pin is asserted to the ON state of the jumper, the output of the TPS22916 is enabled.

6 Test Configurations

6.1 On-Resistance (RON) Test Setup

Figure 6-1 shows a typical setup for measuring on-resistance. The voltage drop across the switch is measured using the sense connections then divided by the current into the load yielding the R_{ON} resistance.

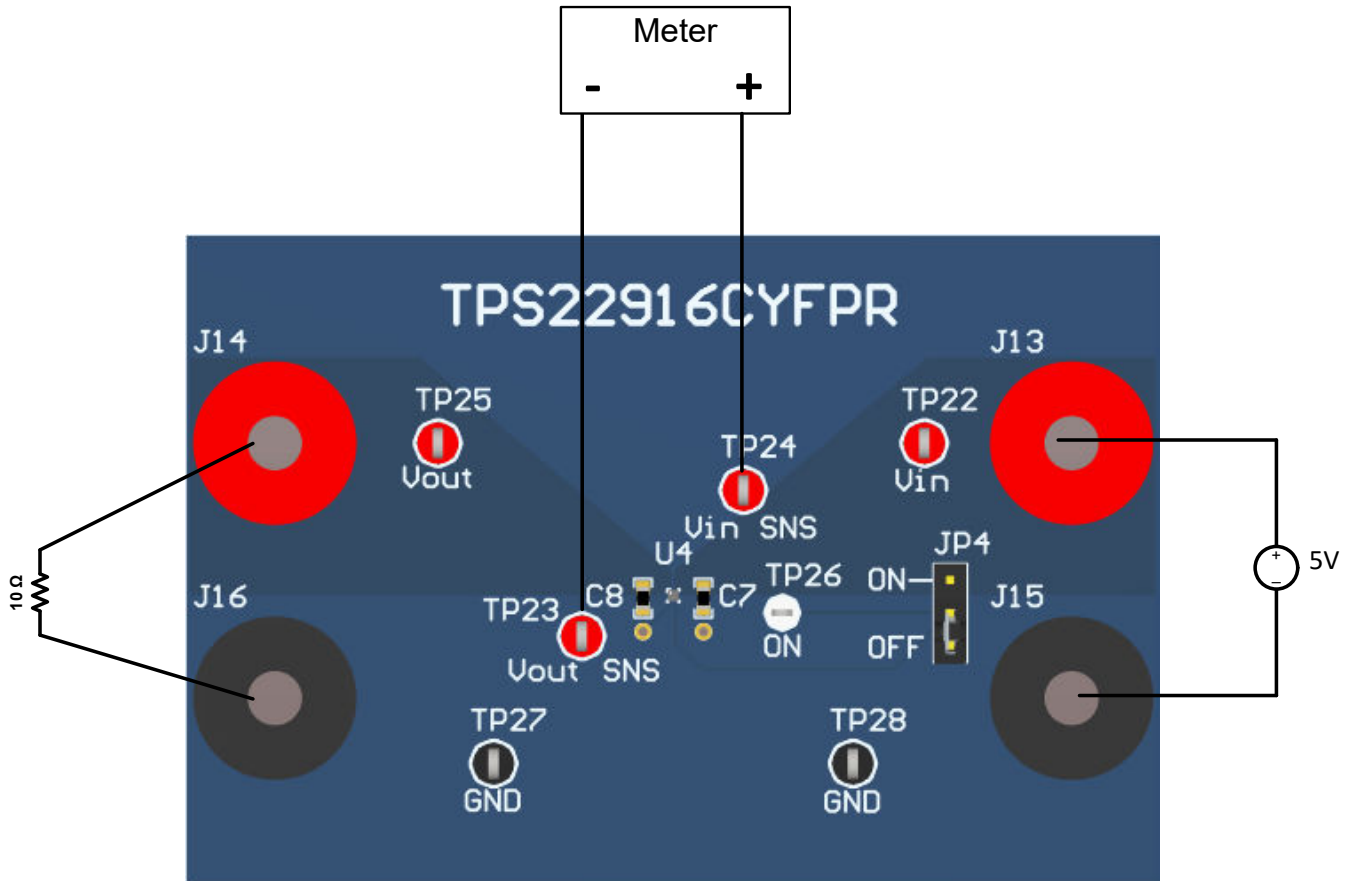


Figure 6-1. R_{ON} Setup

6.2 Slew Rate Test Setup

Figure 6-2 shows a test setup for measuring the slew rate of the load switch. Apply a square wave to the ON pin of the switch using a function generator and apply a voltage to the VIN terminal using a power supply. Observe the waveform at VOUT with a scope to measure the slew rate and rise time of the switch with a given input voltage.

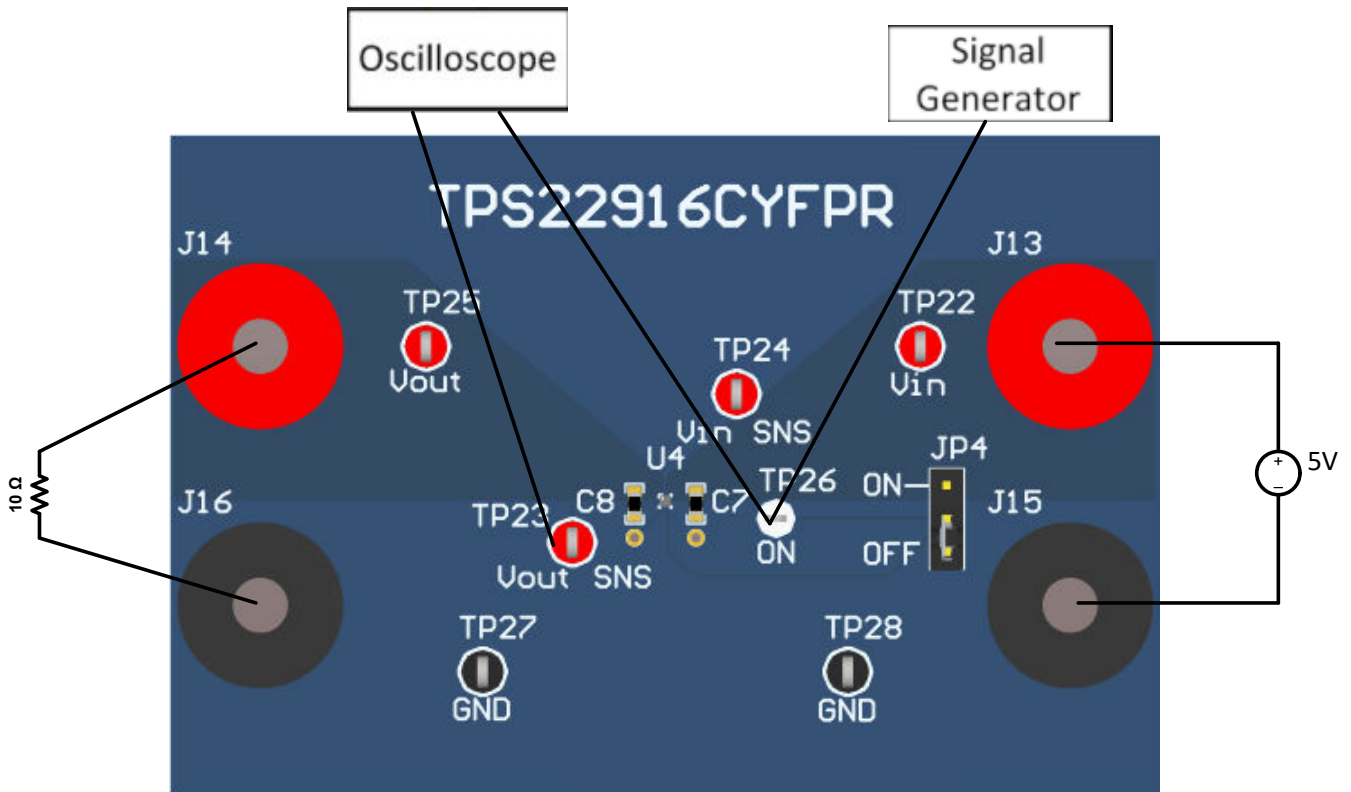


Figure 6-2. Slew Rate Setup

7 Bill of Materials (BOM)

Table 7-1. Bill of Materials

Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer
PCB!	1		Printed Circuit Board		PSIL189	Any
C1, C3, C5, C7, C9, C11	6	1 uF	CAP, CERM, 1 uF, 25 V, +/- 10%, X7R, 0603	603	06033C105KAT2A	AVX
C2, C4, C6, C8, C10, C12	6	0.1 uF	CAP, CERM, 0.1 uF, 16 V, +/- 5%, X7R, 0603	603	0603YC104JAT2A	AVX
J1, J2, J5, J6, J9, J10, J13, J14, J17, J18, J21, J22	12		BANANA JACK, SOLDER LUG, RED, TH	Red Insulated Banana Jack	SPC15363	Tenma
J3, J4, J7, J8, J11, J12, J15, J16, J19, J20, J23, J24	12		BANANA JACK, SOLDER LUG, BLACK, TH	Black Insulated Banana Jack	SPC15354	Tenma
JP1, JP2, JP3, JP4, JP5, JP6	6		Header, 100mil, 3x1, Gold, TH	3x1 Header	TSW-103-07-G-S	Samtec
SH-J1, SH-J2, SH-J3, SH-J4, SH-J5, SH-J6	6		Shunt, 2.54mm, Gold, Black	Shunt, 2.54mm, Black	60900213421	Wurth Elektronik
TP1, TP2, TP3, TP4, TP8, TP9, TP10, TP11, TP15, TP16, TP17, TP18, TP22, TP23, TP24, TP25, TP29, TP30, TP31, TP32, TP36, TP37, TP38, TP39	24		Test Point, Multipurpose, Red, TH	Red Multipurpose Testpoint	5010	Keystone
TP5, TP12, TP19, TP26, TP33, TP40	6		Test Point, Miniature, White, TH	White Miniature Testpoint	5002	Keystone
TP6, TP7, TP13, TP14, TP20, TP21, TP27, TP28, TP34, TP35, TP41, TP42	12		Test Point, Multipurpose, Black, TH	Black Multipurpose Testpoint	5011	Keystone
U1	1		5.5V, 2A, 60mohm Low Leakage Load Switch With RCP, YFP0004ABAB (DSBGA-4)	YFP0004ABAB	TPS22916BYFPR	Texas Instruments
U2	1		5.5V, 2A, 60mohm Low Leakage Load Switch With RCP, YFP0004ABAB (DSBGA-4)	YFP0004ABAB	TPS22916CLYFPR	Texas Instruments
U3	1		5.5V, 2A, 60mohm Low Leakage Load Switch With RCP, YFP0004ABAB (DSBGA-4)	YFP0004ABAB	TPS22916CNYFPR	Texas Instruments
U4	1		5.5V, 2A, 60mohm Low Leakage Load Switch With RCP, YFP0004ABAB (DSBGA-4)	YFP0004ABAB	TPS22916CYFPR	Texas Instruments

Table 7-1. Bill of Materials (continued)

Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer
U5	1		1-V - 5.5-V, 2-A, 60-mΩ Ultra-Low Leakage Load Switch	DSBGA4	TPS22916BLYFPR	Texas Instruments
U6	1		1-V - 5.5-V, 2-A, 60-mΩ Ultra-Low Leakage Load Switch	BGA4	TPS22916CNLYFPR	Texas Instruments

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